

Product Part No. : GT Thermistor

: GT-2 Thermistor

Spec. No.

S04-0156

Application

ACCEPTED BY CUSTOMER

Signature

CHECKED	SUBMITTED
BY	BY
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SEMITEC Ishizuka Electronics Corporation

SPECIFICATIONS	Jser Part No.;	Approved	Checked	Drawn
Application ; P	Part No.; GT-2 Thermistor	Hashida	M. miyake	M. Fukuda.

1. Scope

This specification defines rating, dimensions, electric properties, mechanical properties and climatic properties for the following part.

2. Part No. and Rating

No.	Part No.	Zero-power resistance	Tolerance on zero-power resistance	B-value	Tolerance on B-value	Category temperature range
		R25[k ohm]	[%]	B 25/85[K]	[%]	[deg. C]
1	102GT-2	1.00		3 305		- 50 ~ 200
2	202GT-2	2.00		3 838		
3	502GT-2	5.00		3 964		
4	103GT-2	10.0		4 126		
5	203GT-2	20.0		4 282		
6	503GT-2	50.0	+/- 3	4 288	+/- 2	50 200
7	104GT-2	100		4 267		- 50 ~ 300
8	104GTA-2	100		4 390		
9	204GT-2	200		4 338		
10	504GT-2	500		4 526		
11	105GT-2	1000		4 608		

(The B-value is calculated from zero-power resistance values at 25 deg. C and 85 deg. C.)

3.1 Thermal time constant

Approx. 7.0 s

(in still air)

3.2 Dissipation factor

3.3 Rated maximum power dissipation

Approx. 3.0 mW (in still air at 25 deg.C) (Including self-heat of approx. 5 deg. C.)

Approx. 0.6 mW/deg. C (in still air)

4. Storage temperature range

-10 deg. C ~ 40 deg. C

Company ;	Note ;	Date	Aug.6.2004
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7. Properties

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7.1 Electric properties

Item	Test Conditions	Criteria	
7.1.1 Insulation resistance	Insulation resistance shall be exceed 100M ohm when measured with DC 500V between a glass and a lead wire.	Over 100 M ohm.	
7.1.2 Voltage proof	Voltage proof between a glass and a lead wire shall be more than AC 500 V for 1 min. (Cut-off current: 1 mA)	, and the second s	

7.2 Mechanical properties

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ltem	Test Conditions	Criteria
7.2.1	After a weight of 1N is applied to a wire	Variation of R25 and
Tensile of termination	termination for 10 s +/- 1 s.	B25/85 after the test shall
	1 N	be within +/- 2 % of those
		of the initial values.
		No visible damage.
	10 s +/- 1s	
	Rubber	
7.2.2	With pulling by 0.5N, a lead wire is bent to 90	Variation of R25 and
Bending of termination	degree and bent back to the original position.	B25/85 after the test shall
	Then it is bent likewise in the opposite	be within +/- 2 % of those
	direction. 90° 90°	of the initial values.
		Nobreak down of lead
		wire allowed.
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	0.5 N	

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7.2.3	After three times of natural fall to a maple	Variation of R25 and
Free fall	board from 1 m high.	B25/85 after the test shall
		be within +/- 2 % of those
		of the initial values.
		No visible damage.
7.2.4	Termination of a test sample shall be	Soldered area, shall be
Solderability	immersed one time into solder bath at 245 deg.	more than 75 %.
	C +/- 5 deg. C for 2 s ~ 3 s.	
	Solder : Sn-3.0Ag-0.5Cu	
	flux : rosin 25 %, ethyl alcohol 75 %	
7.2.5	Termination of a test sample shall be	Variation of R25 and
Resistance to	immersed one time into the soldering bath at	B25/85 after the test shall
soldering heat	260 deg. C +/- 5 deg. C to the point 2mm from the body and hold there for 5 s +/- 1 s.	be within +/- 2 % of those of the initial values. No visible damage.
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7.3. Climatic properties

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Item	Test Conditions	Criteria
7.3.1	A test sample is exposed in air at -50 deg. C	Variation of R25 and
Cold	+/- 3 deg. C for 1 000 h and then stored at room temperature and humidity for 1 h.	B25/85 after the test shall be within +/- 2 % of those of the initial values.
7.3.2 Dry heat	A test sample is exposed in air at 300 deg. C (*1: 200 deg. C)+/- 3 deg. C for 1 000 h and then stored at room temperature and humidity	Variation of R25 and B25/85 after the test shall be within +/- 3 %(*2: +/- 5
	for 1 h. (*1):102GT-2	%) of those of the initial values. (*2):104GTA-2
7.3.3 Change of temperature	One cycle of rapid change of temperature shall be proceeded in order of the following conditions. "At room ambient temperature.(initial status)" "At -30 deg. C +/- 5 deg. C for 5 min." "At room temperature for 3 min." "At 200 deg. C(*1: 150 deg. C)+/- 5 deg. C for 5 min." "At room temperature for 3 min." 5 cycles of rapid change of temperature are applied to the test samples, and then stored at room temperature and humidity for 1 h. (*1):102GT-2	Variation of R25 and B25/85 after the test shall be within +/- 2 % of those of the initial values.

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7.3.4 Damp heat	then stored at room temperature and humidity	Variation of R25 and B25/85 after the test shall be within +/- 2 % of those of the initial values.
7.3.5 Damp heat (Under loading)	5 deg. C, 90 %RH ~ 95 %RH with the DC 0.1	Variation of R25 and B25/85 after the test shall be within +/- 2 % of those of the initial values.

Note

"Room temperature" is defined as the temperature between 15 deg.C to 35 deg.C. "Room humidity" is defined as the humidity between 25 %RH to 75 %RH.

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Rev	vision	records
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Revision No.	Date	Revised by	Revision item	Former	specification	New specification
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